March 2015



# FGH40N65UFD 650 V, 40 A Field Stop IGBT

#### Features

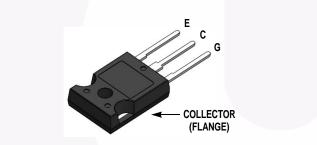
- High Current Capability
- Low Saturation Voltage: V<sub>CE(sat)</sub> = 1.8 V @ I<sub>C</sub> = 40 A
- High Input Impedance
- Fast Switching
- RoHS Compliant

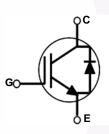
### Applications

• Solar Inverter, UPS, Welder, PFC

## **General Description**

Using novel field stop IGBT technology, Fairchild's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.





### **Absolute Maximum Ratings**

Symbol	Description		Ratings	Unit
V <sub>CES</sub>	Collector to Emitter Voltage		650	V
M	Gate to Emitter Voltage	±20	- V	
V <sub>GES</sub>	Transient Gate-to-Emitter Voltage	±30		
	Collector Current	@ T <sub>C</sub> = 25°C	80	А
IC	Collector Current	@ T <sub>C</sub> = 100 <sup>o</sup> C	40	А
I <sub>CM (1)</sub>	Pulsed Collector Current	@ T <sub>C</sub> = 25°C	120	А
P <sub>D</sub>	Maximum Power Dissipation	@ T <sub>C</sub> = 25°C	290	W
' D	Maximum Power Dissipation	@ T <sub>C</sub> = 100 <sup>o</sup> C	116	W
TJ	Operating Junction Temperature		-55 to +150	°C
T <sub>stg</sub>	Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

### **Thermal Characteristics**

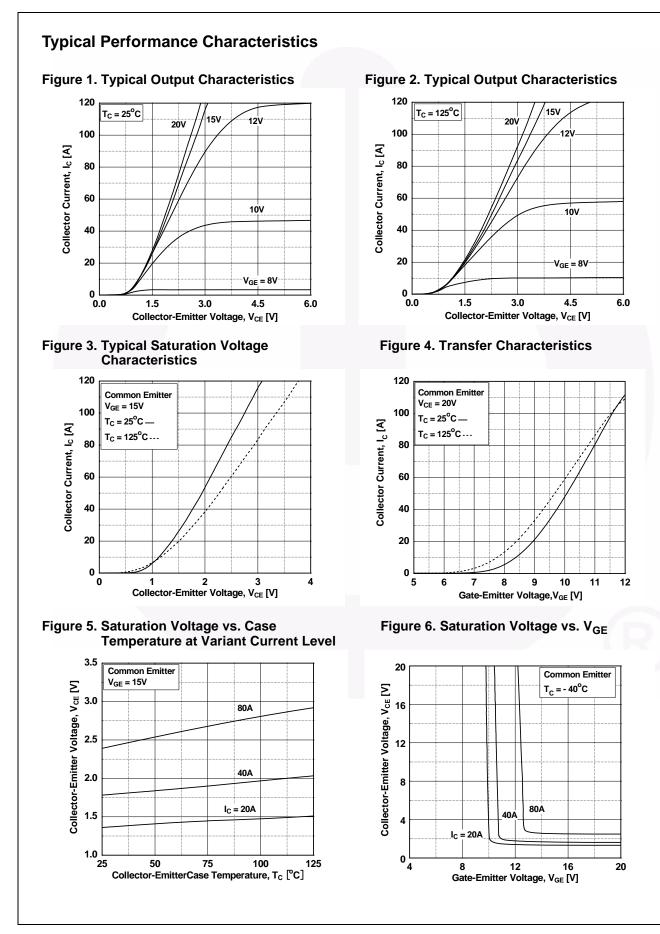
Symbol	Parameter	Тур.	Max.	Unit	
R <sub>0JC</sub> (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W	
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W	

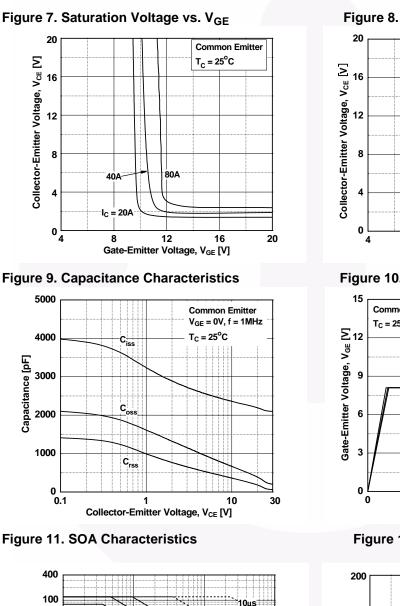
Part Number Top Mark Package		Packing Method	Reel Size	Tape Width		Quantity		
FGH40N65UFDTU FGH40N65UFD TO-247		Tube	N/A	N/A		30		
Electric	al Cha	aracteristics	of the IG	<b>BT</b> T <sub>C</sub> = 25°C unless otherw	rise noted			
Symbol	nbol Parameter			Test Condition	s Min.	Тур.	Max.	Unit
Off Charac	teristics							
BV <sub>CES</sub>			V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA 650				V	
$\Delta BV_{CES}$ / $\Delta T_{J}$	Temperature Coefficient of Breakdown Voltage		V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA	-	0.6	-	V/ºC	
ICES	Collecto	ector Cut-Off Current		V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	-	250	μA
I <sub>GES</sub>	G-E Lea	kage Current		$V_{GE} = V_{GES}, V_{CE} = 0 V$			±400	nA
On Charac V <sub>GE(th)</sub>		eshold Voltage		I <sub>C</sub> = 250 μA, V <sub>CE</sub> = V <sub>GE</sub>	4.0	5.0	6.5	V
			$I_{\rm C} = 40$ A, $V_{\rm GE} = 15$ V	-	1.8	2.4	v	
V <sub>CE(sat)</sub>	Collecto	r to Emitter Saturat	· · · · · / · / · · · ·	$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 125^{\circ}\text{C}$	-	2.0	-	V
Dynamic (	1	istics				2110		۶Ę
C <sub>ies</sub>		Capacitance		V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,				P.
C <sub>oes</sub> C <sub>res</sub>				f = 1 MHz	-	200 60	-	pF pF
Vres	1/6/6136				-	00	-	р
Switching								
t <sub>d(on)</sub>		Turn-On Delay Time			-	24	-	ns
t <sub>r</sub>					-	44	-	ns
t <sub>d(off)</sub>		Delay Time		$V_{CC} = 400 \text{ V}, I_{C} = 40 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$	-	112	-	ns
t <sub>f</sub>	Fall Tim	-		$R_G = 10 \Omega_2$ , $v_{GE} = 15 v$ , Inductive Load, $T_C = 25^{\circ}C$	-	30	60	ns
E <sub>on</sub>		Switching Loss		-	-	1.19	-	mJ
E <sub>off</sub>		Switching Loss			-	0.46	-	mJ
E <sub>ts</sub>		vitching Loss			-	1.65	-	mJ
t <sub>d(on)</sub>		Delay Time			-	24	-	ns
t <sub>r</sub>	Rise Tin				-	45	-	ns
t <sub>d(off)</sub>		Delay Time		$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{ V},$ Inductive Load, $T_{C} = 125^{\circ}$	-	120	-	ns
t <sub>f</sub>	Fall Tim	-			- O	40	-	ns
E <sub>on</sub>		Switching Loss		~	-	1.2	-	mJ
E <sub>off</sub>		Switching Loss			-	0.69	-	mJ
E <sub>ts</sub>		vitching Loss			-	1.89	-	mJ
Qg		te Charge		V <sub>CE</sub> = 400 V, I <sub>C</sub> = 40 A,	-	120	-	nC
Q <sub>ge</sub> Q <sub>gc</sub>		Emitter Charge		$V_{GE} = 400 \text{ V}, 10 = 40 \text{ A},$ $V_{GE} = 15 \text{ V}$	-	14	-	nC
		te to Collector Charge			-	58	-	r

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D   6
650 V, 40
) A Fiel
ld Stop
0 IGB1

Symbol	Parameter	Test Conditions		Min.	Тур.	Max	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 20 A	$T_C = 25^{\circ}C$	-	1.95	2.6	V
* F M			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	1.85	-	
+	Diode Reverse Recovery Time	I <sub>F</sub> =20 A, di <sub>F</sub> /dt = 200 A/μs	$T_{\rm C} = 25^{\rm o}{\rm C}$	-	45	-	ns
۲r			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	140	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge		$T_{\rm C} = 25^{\rm o}{\rm C}$	-	75	-	nC
∝ll			$T_{\rm C} = 125^{\rm o}{\rm C}$	-	375	-	

FGH40N65UFD — 650 V, 40 A Field Stop IGBT





### **Typical Performance Characteristics**

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Collector Current, I<sub>c</sub> [A]

10

1

0.1

0.01

1

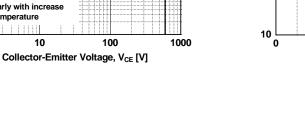
Single Nonrepetitive

Curves must be derated linearly with increase

10

Pulse T<sub>C</sub> = 25<sup>0</sup>C

in temperature



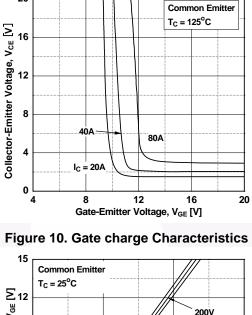
100µs

1ms 10 ms

DC

100

Figure 8. Saturation Voltage vs. V<sub>GE</sub>



= 100V

300V

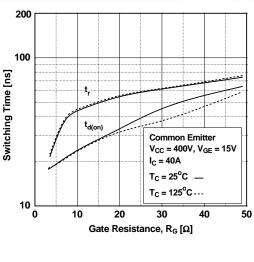
100

150

Figure 12. Turn-on Characteristics vs. **Gate Resistance** 

Gate Charge, Qg [nC]

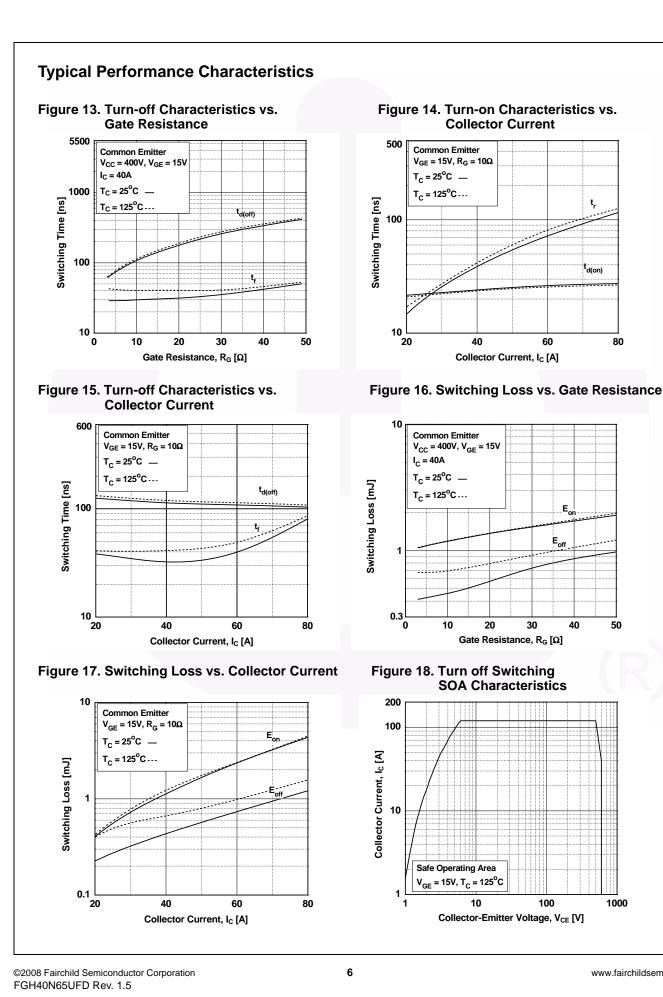
50



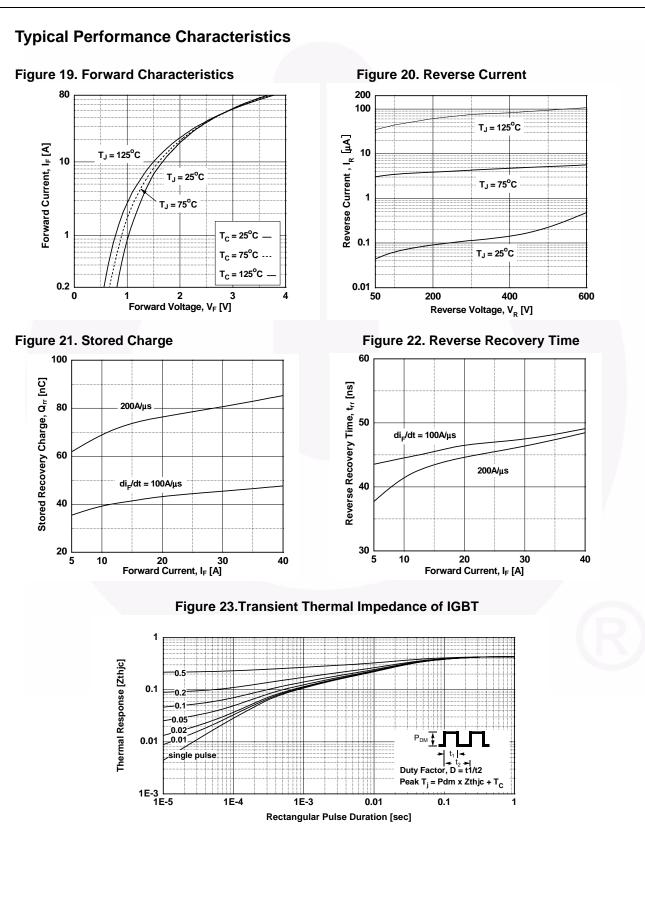
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80

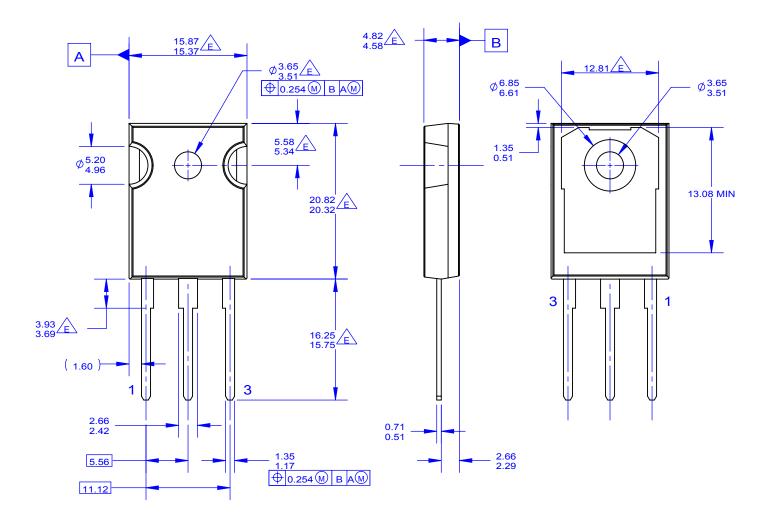
50



1000



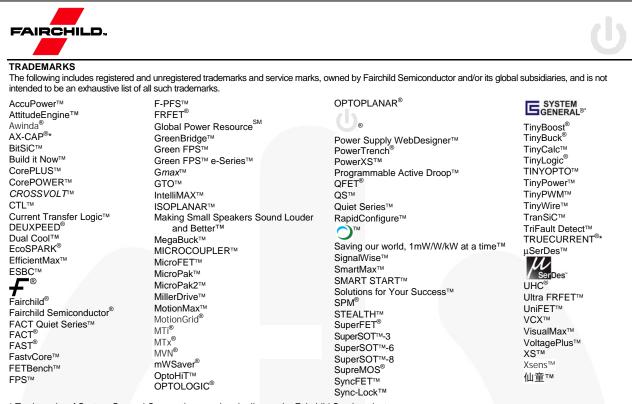
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